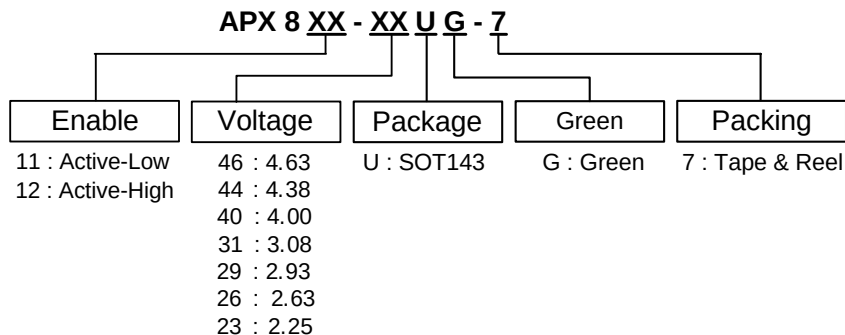


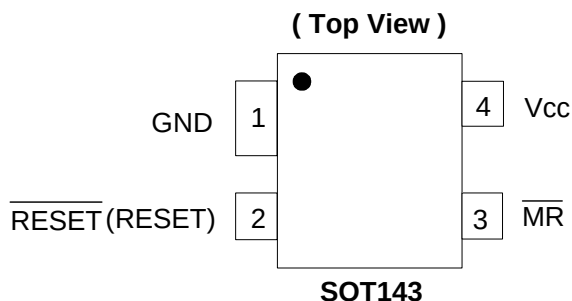
### Ordering Information



| Device        | Package Code | Packaging (Note 2) | 7" Tape and Reel |                    |
|---------------|--------------|--------------------|------------------|--------------------|
|               |              |                    | Quantity         | Part Number Suffix |
| APX811-XXUG-7 | U            | SOT143             | 3000/Tape & Reel | -7                 |
| APX812-XXUG-7 | U            | SOT143             | 3000/Tape & Reel | -7                 |

- Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at [http://www.diodes.com/products/lead\\_free.html](http://www.diodes.com/products/lead_free.html).
  2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

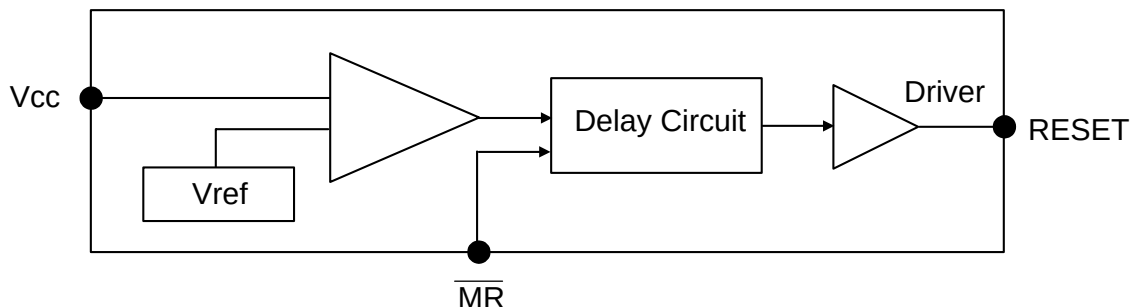
### Pin Assignments



### Pin Descriptions

| Pin Name      | Description                                        |
|---------------|----------------------------------------------------|
| GND           | Ground                                             |
| RESET (RESET) | Reset output Pin<br>L: for APX811<br>H: for APX812 |
| VCC           | Operating Voltage Input                            |
| MR            | Manual reset (Active Low)                          |

## Block Diagram



## Absolute Maximum Ratings

| Symbol      | Parameter                       | Rating                   | Unit |
|-------------|---------------------------------|--------------------------|------|
| ESD HBM     | Human Body Model ESD protection | 3                        | kV   |
| ESD MM      | Machine Model ESD Protection    | 500                      | V    |
| $V_{CC}$    | Supply voltage                  | -0.3~7                   | V    |
| $V_{RESET}$ | RESET                           | -0.3 to ( $V_{CC}+0.3$ ) | V    |
| $I_{CC}$    | Input Current, $V_{CC}$         | 20                       | mA   |
| $I_O$       | Output current                  | 20                       | mA   |
| $P_D$       | Power dissipation               | 320                      | mW   |

## Recommended Operating Conditions

| Symbol   | Parameter                     | Min | Max              | Unit |
|----------|-------------------------------|-----|------------------|------|
| $V_{CC}$ | Supply Voltage                | 1.1 | 5.5              | V    |
| $V_{IN}$ | Input Voltage                 | 0   | ( $V_{CC}+0.3$ ) | V    |
| $T_A$    | Operating Ambient Temperature | -40 | 85               | °C   |

### Electrical Characteristics (T<sub>A</sub> = 25°C)

T<sub>A</sub> = -40 to 85 °C unless otherwise note. Typical values are at T<sub>A</sub> = +25 °C.

| Symbol          | Parameter                              | Test Conditions                                                             | Min                   | Typ. | Max  | Unit |
|-----------------|----------------------------------------|-----------------------------------------------------------------------------|-----------------------|------|------|------|
| V <sub>CC</sub> | V <sub>CC</sub> Range                  |                                                                             | 1.0                   |      | 5.5  | V    |
| I <sub>CC</sub> | Supply Current                         | V <sub>th</sub> + 0.2V                                                      |                       | 30   | 40   | μA   |
| V <sub>th</sub> | Reset threshold                        | T <sub>A</sub> = 25 °C.                                                     | 2.22                  | 2.25 | 2.28 | V    |
|                 |                                        |                                                                             | 2.59                  | 2.63 | 2.67 | V    |
|                 |                                        |                                                                             | 2.89                  | 2.93 | 2.98 | V    |
|                 |                                        |                                                                             | 3.03                  | 3.08 | 3.13 | V    |
|                 |                                        |                                                                             | 3.94                  | 4.00 | 4.06 | V    |
|                 |                                        |                                                                             | 4.31                  | 4.38 | 4.45 | V    |
|                 |                                        |                                                                             | 4.56                  | 4.63 | 4.70 | V    |
| t <sub>s</sub>  | Set-up Time                            | V <sub>CC</sub> = V <sub>th</sub> to (V <sub>th</sub> - 100mV)              |                       | 20   |      | μs   |
| V <sub>OL</sub> | RESET Output Voltage Low (APX811)      | V <sub>CC</sub> = V <sub>th</sub> - 0.2, I <sub>SINK</sub> = 1.2mA          |                       |      | 0.3  | V    |
|                 |                                        | V <sub>CC</sub> = V <sub>th</sub> - 0.2, I <sub>SINK</sub> = 3.2mA          |                       |      | 0.4  |      |
|                 |                                        | V <sub>CC</sub> > 1.0V, I <sub>SINK</sub> = 50uA                            |                       |      | 0.3  |      |
| V <sub>OH</sub> | RESET Output Voltage-High (APX811)     | V <sub>CC</sub> > V <sub>th</sub> + 0.2, I <sub>SOURCE</sub> = 500uA        | 0.8V <sub>CC</sub>    |      |      | V    |
|                 |                                        | V <sub>CC</sub> > V <sub>th</sub> + 0.2, I <sub>SOURCE</sub> = 800uA        | V <sub>CC</sub> - 1.5 |      |      |      |
| V <sub>OL</sub> | RESET Output Voltage-Low (APX812)      | V <sub>CC</sub> = V <sub>th</sub> + 0.2, I <sub>SINK</sub> = 1.2mA          |                       |      | 0.3  | V    |
|                 |                                        | V <sub>CC</sub> = V <sub>th</sub> + 0.2, I <sub>SINK</sub> = 3.2mA          |                       |      | 0.4  |      |
| V <sub>OH</sub> | RESET Output Voltage-High (APX812)     | 1.8V < V <sub>CC</sub> < V <sub>th</sub> - 0.2, I <sub>SOURCE</sub> = 150uA | 0.8 V <sub>CC</sub>   |      |      | V    |
| θ <sub>JA</sub> | Thermal Resistance Junction-to-Ambient | SOT143 (Note 3)                                                             |                       | 240  |      | °C/W |
| θ <sub>JC</sub> | Thermal Resistance Junction-to-Case    | SOT143 (Note 3)                                                             |                       | 71   |      | °C/W |

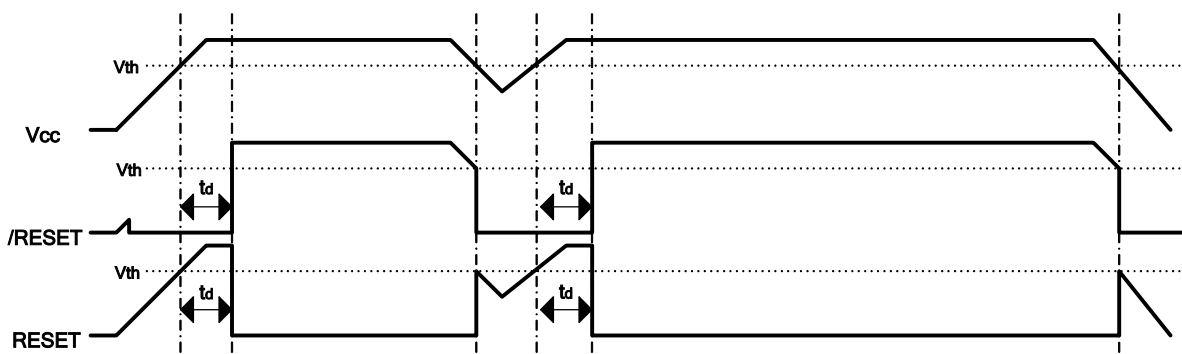
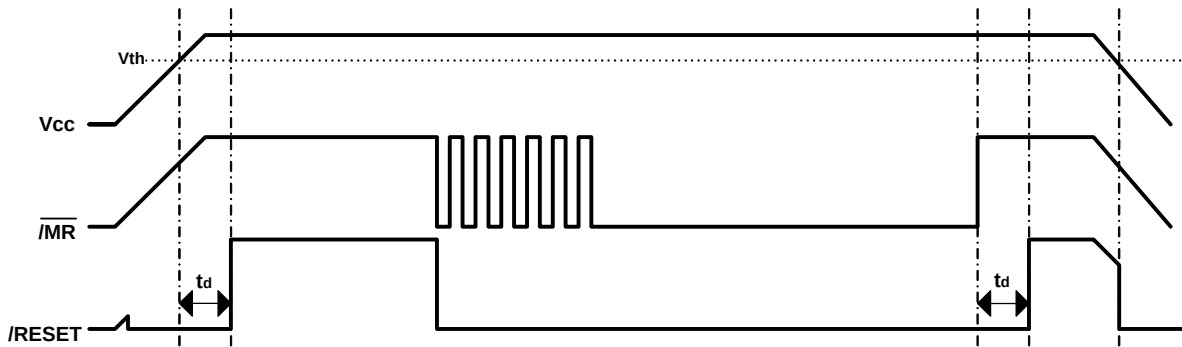
Notes: 3. Test condition for SOT143: Device mounted on FR-4 substrate, 1"×1", 2oz, copper, single-sided, PC boards.

### Timing requirements (T<sub>A</sub> = 25°C)

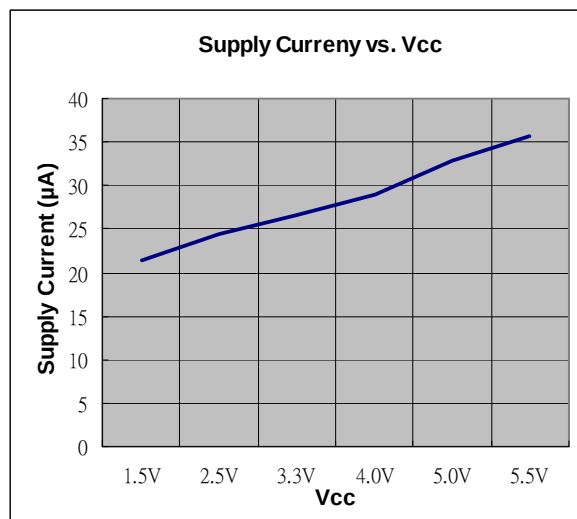
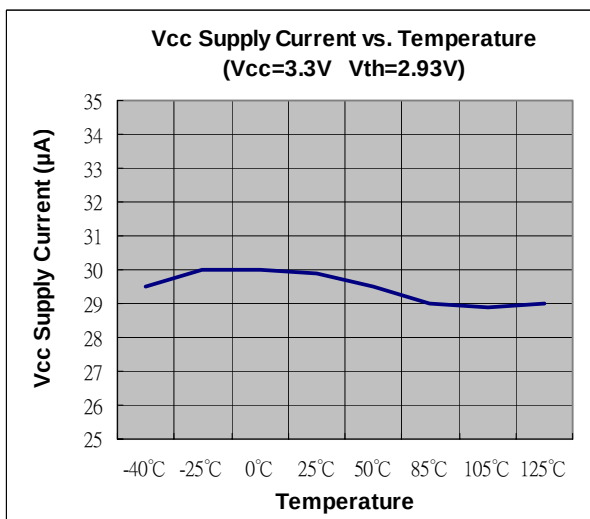
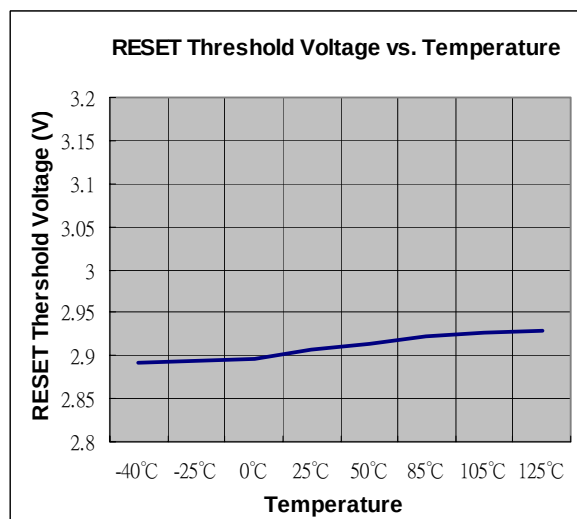
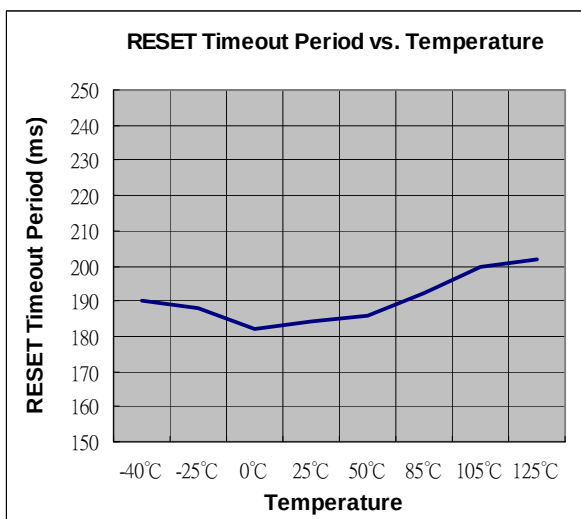
| Symbol         | Parameter         | Test Conditions                                                                                                             | Min | Typ. | Max | Unit |
|----------------|-------------------|-----------------------------------------------------------------------------------------------------------------------------|-----|------|-----|------|
| t <sub>w</sub> | Pulse Width at MR | V <sub>CC</sub> > V <sub>th</sub> + 0.2V, V <sub>IL</sub> = 0.3 × V <sub>CC</sub> , V <sub>IH</sub> = 0.7 × V <sub>CC</sub> | 100 | -    | -   | ns   |

**Switching Characteristics** ( $T_A=25^\circ\text{C}$ )

| Symbol    | Parameter                                             |                                                                           | Test Conditions                                                                              | Min | Typ. | Max | Unit          |
|-----------|-------------------------------------------------------|---------------------------------------------------------------------------|----------------------------------------------------------------------------------------------|-----|------|-----|---------------|
| $t_d$     | Delay Time                                            | APX811/812                                                                | $V_{CC} > V_{th} + 0.2V$ ,<br>See timing diagram                                             | 140 | 200  | 280 | ms            |
| $t_{PHL}$ | Propagation (Delay) Time,<br>High-to-low-level Output | $\overline{\text{MR}}$ to $\overline{\text{RESET}}$<br>delay (APX811/812) | $V_{CC} > V_{th} + 0.2V$ ,<br>$V_{IL} = 0.3 \times V_{CC}$ ,<br>$V_{IH} = 0.7 \times V_{CC}$ | -   | -    | 0.1 | $\mu\text{s}$ |
|           |                                                       | $V_{CC}$ to $\overline{\text{RESET}}$ delay                               | $V_{IL} = V_{th} - 0.2V$ ,<br>$V_{IH} = V_{th} + 0.2V$                                       | -   | -    | 25  | $\mu\text{s}$ |
| $t_{PLH}$ | Propagation (Delay) Time,<br>Low-to-high-level Output | $\overline{\text{MR}}$ to $\overline{\text{RESET}}$ delay<br>(APX811/812) | $V_{CC} > V_{th} + 0.2V$ ,<br>$V_{IL} = 0.3 \times V_{CC}$ ,<br>$V_{IH} = 0.7 \times V_{CC}$ | -   | -    | 0.1 | $\mu\text{s}$ |
|           |                                                       | $V_{CC}$ to $\overline{\text{RESET}}$ delay<br>(APX811/812)               | $V_{IL} = V_{th} - 0.2V$ ,<br>$V_{IH} = V_{th} + 0.2V$                                       | -   | -    | 25  | $\mu\text{s}$ |

**Timing Diagram**
**RESET vs. Vcc Timing Diagram**

**RESET vs. /MR Timing Diagram**


## Typical Performance Characteristics



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### Application Information

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A microprocessor's ( $\mu$ P's) reset input starts the  $\mu$ P in a known state. The APX811/812 asserts reset to prevent code-execution errors during power-up, power-down, or brownout conditions. They assert a reset signal whenever the  $V_{CC}$  supply voltage declines below a preset threshold or the  $\overline{MR}$  pin is brought low, keeping it asserted for at least 240ms after  $V_{CC}$  has risen above the reset threshold. The APX811/812 have a push-pull output stage.

The APX811/812 reset output is guaranteed to be logic low for the APX811 and high the APX812 for  $V_{CC} > 1V$ . Once  $V_{CC}$  exceeds the reset threshold, an internal timer keeps  $\overline{RESET}$  output low (and RESET high for the APX812) for the reset timeout period. After this interval, the APX811's  $\overline{RESET}$  output goes high (APX812's RESET output goes low). If a brownout condition occurs ( $V_{CC}$  dips below the reset threshold), the APX811's  $\overline{RESET}$  output goes low (APX812's RESET output goes high). Any time  $V_{CC}$  goes below the reset threshold, the internal timer resets to zero, and  $\overline{RESET}$  goes low (RESET goes high). The internal timer starts after  $V_{CC}$  returns above the reset threshold, and  $\overline{RESET}$  remains low (RESET remains high) for the reset timeout period.

#### Ensuring a Valid Reset Output Down to $V_{CC} = 0$

When  $V_{CC}$  falls below 1V, the APX811  $\overline{RESET}$  no longer sinks current—it becomes an open circuit. Therefore, high-impedance CMOS logic inputs connected to  $\overline{RESET}$  can drift to undetermined voltages. This presents no problem in most applications since most  $\mu$ P and other circuitry is inoperative with  $V_{CC}$  below 1V. However, in applications where  $\overline{RESET}$  must be valid down to 0V, adding a pull down resistor to  $\overline{RESET}$  causes any stray leakage currents to flow to ground, holding  $\overline{RESET}$  low. R1's value is not critical; 100k is large enough not to load  $\overline{RESET}$  and small enough to pull  $\overline{RESET}$  to ground.

For the APX812 if RESET is required to remain valid for  $V_{CC} < 1V$  then a 100k $\Omega$  pull-up resistor between RESET and  $V_{CC}$  is recommended.

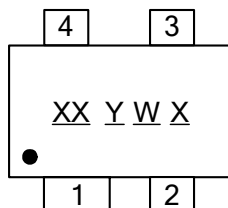
#### Benefits of Highly Accurate Reset Threshold

Most  $\mu$ P supervisor ICs has reset threshold voltages between 5% and 10% below the value of nominal supply voltages. This ensures a reset will not occur within 5% of the nominal supply, but will occur when the supply is 10% below nominal. When using ICs rated at only the nominal supply  $\pm 5\%$ , this leaves a zone of uncertainty where the supply is between 5% and 10% low, and where the reset may or may not be asserted.

### Marking Information

(1) SOT143

( Top View )



XX : Identification code

Y : Year 0~9

W : Week : A~Z : 1~26 week;  
a~z : 27~52 week; z represents  
52 and 53 week

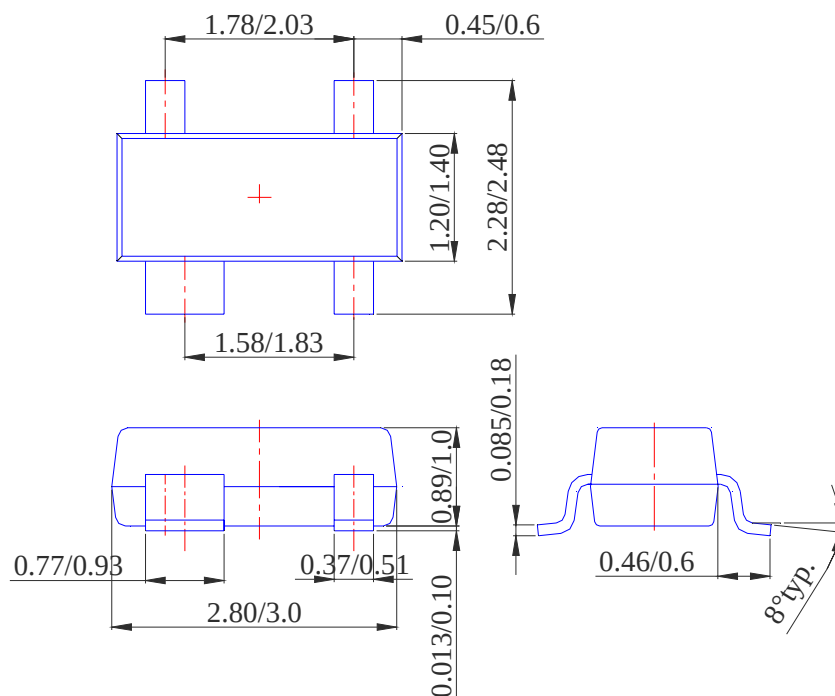
X : A~Z : Green

| Device     | Package | Identification Code |
|------------|---------|---------------------|
| APX811-46U | SOT143  | C2                  |
| APX811-44U | SOT143  | C3                  |
| APX811-40U | SOT143  | C4                  |
| APX811-31U | SOT143  | C5                  |
| APX811-29U | SOT143  | C6                  |
| APX811-26U | SOT143  | C7                  |
| APX811-23U | SOT143  | C8                  |
| APX812-46U | SOT143  | C9                  |
| APX812-44U | SOT143  | CA                  |
| APX812-40U | SOT143  | CB                  |
| APX812-31U | SOT143  | CC                  |
| APX812-29U | SOT143  | CD                  |
| APX812-26U | SOT143  | CE                  |
| APX812-23U | SOT143  | CF                  |

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**Package Information** (All Dimensions in mm)

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**(1) Package Type: SOT143**



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